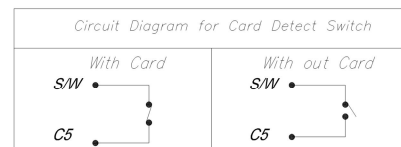
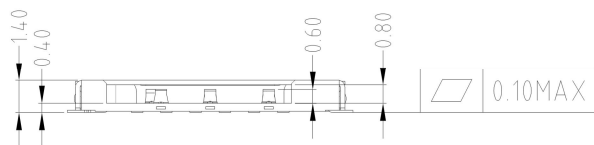
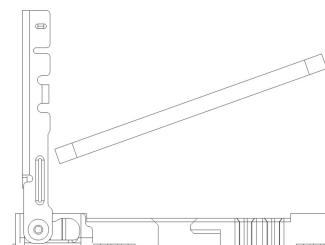


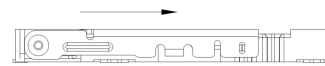
P.C.B LAYOUT MOUNTING PATTERN



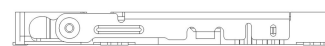
PIN NO.	PIN NAME
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O
S/W	SWTSH PIN



STEP 1 INSERT NANO SIM CARD



STEP 2 PUSH THE SHELL



STEP 3 FINISH

SPECIFICATION:

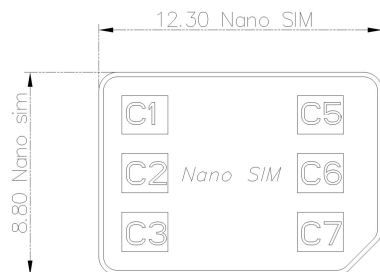
1. CURRENT RATING : 0.5 mA AC / DC MAX.
2. VOLTAGE RATING : 5V AC / DC
3. INSULATION RESISTANCE : 100MΩ MIN.
4. CONTACT RESISTANCE : 80mΩ MAX.
5. OPERATING TEMPERATURE : -40°C TO +85°C.
6. STORAGE TEMPERATURE : -40°C TO +85°C.
7. LIFE : 5000 CYCLES

MATERIALS:

1. HOUSING : LCP
2. CONTACT : PHOSPHOR BRONZE
3. SHELL : SUS

Finish:

1. Finish: CONTACT: PLATED GOLD IN MATING AREA ;
GOLD PLATED ON SOLDER BALLS ;
NICKEL UNDER PLATED OVERALL
2. SHELL: NICKEL UNDER PLATED SURFACE LAYER



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DONG GUAN XI BANG ELECTRONI CS CO., LTD.

TOLERANCE UNLESS OTHERWISE STATED:
Up to 5 ±0.2
Above 5 ~ 15 ±0.3
Above 15 ~ 30 ±0.4
Above 30 ~ 50 ±0.5
Angle ±0.3

3RD. ANGEL'S



UNITS MM

DRAWN BY: Jack Lu
CHECKED BY: Jacky Chen
APPROVED BY: Tony Kao
DATE: 07/27/23

MAT'L	TITLE	CONNECTOR
FINISH	MODLE	Nano SIM CARD 掀蓋 1.40H 7P 帶開關
SCALE	DWG NO.	NSIM-SFB007R-S267
SHEET NO.	PART NO.	NSIM-SFB007R-S267

ITEM NO.	DESCRIPTION	DRAWN	DATE
4	新增平整度標示	Jack	072723
3	新增pin編號	Jack	091322
2	更新料號	Jack	070522
1	更新OPERATING TEMPERATURE	Jack	080621

7

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SIZE A4
VER R4